SPECIFICATION

Graphic Type STN Dot Matrix LCD Module

G12832A



1. GENERAL SPECIFICATION

 128×32 dots display

SAM SUNG LCD driver:KS0107B and KS0108B

Interface with 8-bit MPU (directly connected to M6800serial MPU)

Display specification

Display dot: 128×32

Display type: STN

Display color-Display background color: Black-Yellow Green

Polarizer mode: positive; Transflective

Viewing angle:6:00

Display RAM:8192 bits

Mechanical characteristics (Unit: mm)

External dimension: $110 \times 65 \times 13.4$

View area: 77.6X24.6

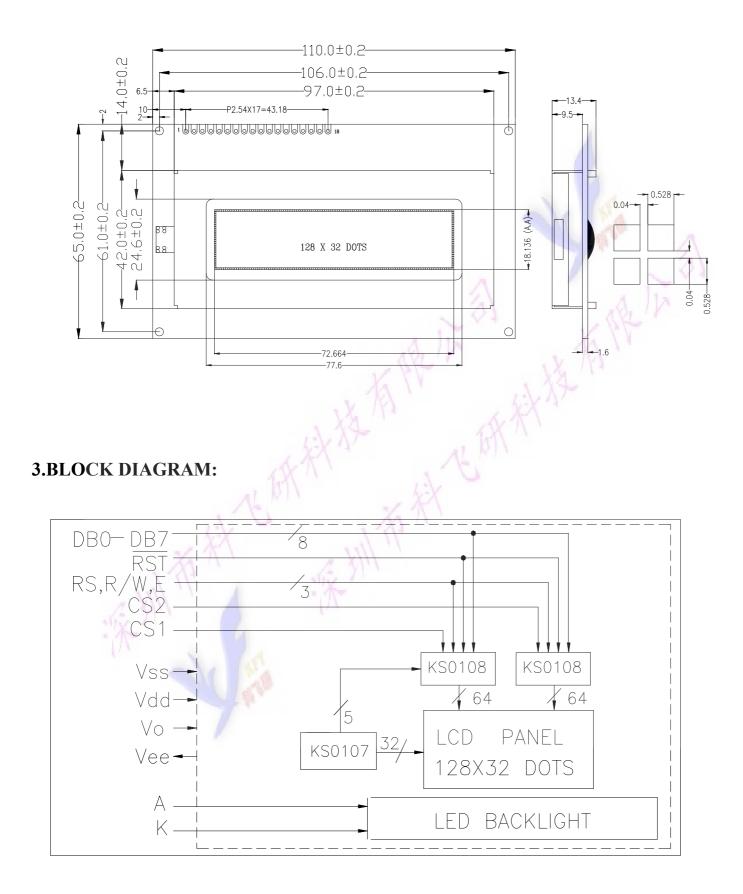
Dot size: 0.528X0.528

Dot pitch: 0.568X0.568

Weight:

POWER: +5V

2.OUTLINE DEMENSION:



4 Absolute Maximum Ratings For Bottom LED Backlight

Parameter	Symbol	Test condition	Min	Туре	Max	Unit
LED Forward Consumption Current	I _f	Ta=25°C	-	80	100	mA
LED Allowable Dissipation	P _d	Vf=4.1V	-	328	410	mW

5 Absolute Maximum Ratings

Itom	Symbol	Condition	Standar	d Value	Unit
Item	Symbol	Condition	Min	Max 7.0 Vdd+0.3	Unit
Supply voltage for logic	Vdd		-0.3	7.0	VV
Supply voltage for LCD	Vo	Ta=25°C	Vdd-5.0	Vdd+0.3	V
Input Voltage	Vi	S YV	-0.3	Vdd+0.3	V
Operating Temp(T)	Тор	-	-20	70	⁰ C
Storage Temp(T)	Tstg	A.	-30	80	⁰ C

6. ELECTRICAL SPECIFICATIONS(Ta=25°C,Vdd=5.0V)

-/ 21	111		Star	ndard Val	lue	
ltem	Symbol	Condition	Min	Туре	Max	Unit
Supply voltage for logic	Vdd-Vss	-	4.5	5.0	5.5	V
Supply Current for logic	Idd	Vdd=5.0	-	3.0	-	mA
Driving Current for LCD	Iee	Vee=-7.8	-	2.8	-	mA
Driving Voltage for LCD	Vo	25 [°] C -	-	9.2	-	V
Input Voltage "H" level	Vih1	Н	0.7Vdd	-	Vdd	V
	Vih2		2.0V	-	Vdd	
Input Voltage "L" level	Vil1	L	0	-	0.3Vdd	V
	Vil2		0	-	0.8V	
Notes:Vil	n2,Vil2: CS,RS,R/V	W,E.DATA BU	S; Vih1,V	/il1:/RS7	ſ	

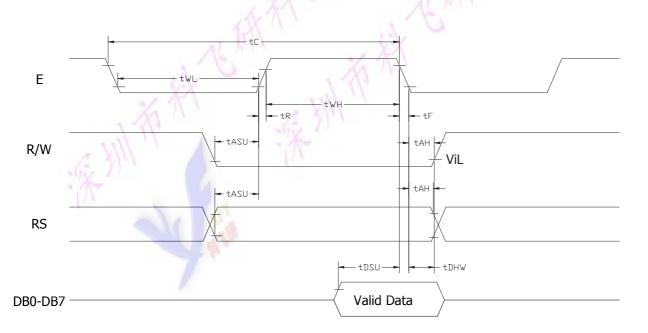
7. Pin assignment

Pin NO.	Symbol	Fi	Remark					
1	Vee	Negative						
2	Vd		+5V					
3	Vss	Power Supply	1					
4	Е	Enable	8	1201				
5	RS	Register Select (H	E'r					
6	R/W	L:MPU to LC	L:MPU to LCM H:CLM to MPU					
7	/RST	R	ESET					
8	CS	Chip	Select (H)					
9~16	DB7~DB0	D	Data Bus					
17	A	Anode	Anode of LED Unit					
18	K	Cathode	of LED Unit					

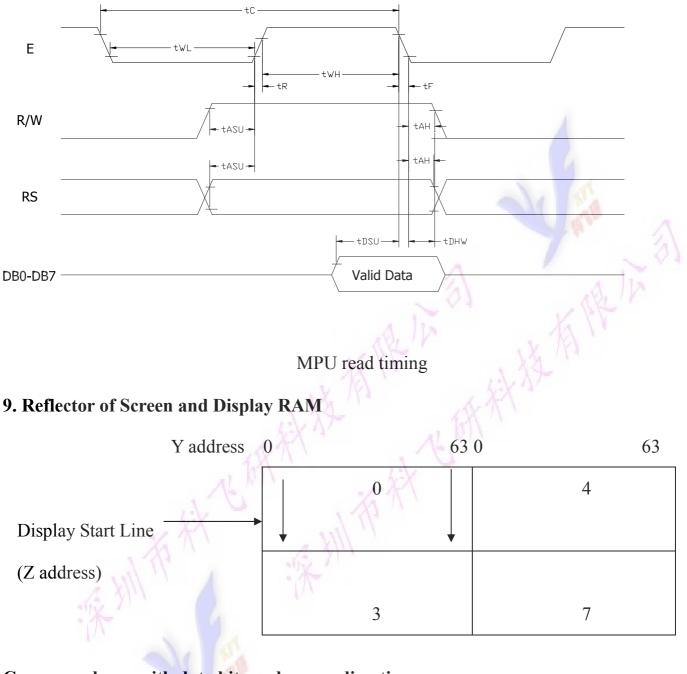
8. MPU Interface

G12832A

Characteristic	Symbol	Min	Тур	Max	Unit
E Cyele	Тс	1000	-	-	ns
E High Level Width	Twh	450	-	-	ns
E Low Level Width	Twl	450	-	-	ns
E Rise Time	Tr	-	-	25	ns
E Fall Time	Tf	-	-	25	ns
Address Ste-Up Time	Tasu	140	- 🛁	- IT	ns
Address Hold Time	Tah	10	-	-ALAN	ns
Data Set-Up Time	Tdsu	200	2-		ns
Data Delay Time	Td	TA DI		320	ns
Data Hold Time(Write)	Tdhw	10	- ,)	A.M	ns
Data Hold Time(Read)	tdhr	20	it KX	-	ns



MPU writing timing



Correspondence with data bits and arrow direction

DB0 DB1 DB2 DB3 DB4 DB5 DB6 DB7

10. DISPLAY CONTROL INSTRUCTION

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display ON/OFF	L	L	L	L	Н	Н	Н	Н	Н	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L:OFF, H:ON
Set address (Y address)	L	L	L	Η		Y	ria	Sets the Y address in the Y address counter			
Set page (X address)	L	L	н	L	Н	н	7)	Sets the Y address at the X address register.			
Display Start Line (Z address)	L	L	н	н Дэд	家	Displ		Indicates the display data RAM displayed at the top of the screen.			
Status Read	L	H.	B U S Y	L	O N / O F F	R E S E T	L	L	L	L	BUSY L: Ready H: In operation ON/OFF L: Display OFF RESET L: Normal H: Reset
Write Display Data	н	L	IT IS			1	Writes data (DB0:7)into Display data RAM, After writing instruction, Y address is increased by 1 automatically.				
Read Display Data	Н	Н			Read Data						Reads data (DB0:7)from display data RAM to the data bus.

1. Display On/Off

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	0	0

The display data appears when D is 1 and disappears when D is 0.

Though the data is not in the screen with D=0,it remains in the display data RAM.

Therefore, you can make it appear by changing D=0 into D=1.

2 .Set Address(Y Address)

RS	R/	W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	(0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Y address (AC0-AC5) of the display data RAM is set in the Y address counter.

An address is set by instruction and increased by 1 automatically by read or write operations of display data.

3.Set Page(X Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	AC2	AC1	AC0

X address (AC0-AC2) of the display data RAM is set in the X address register,

Writing or reading to or from MPU is executed in this specified page until next page is set.

4.Display Start Line (Z Address)

F	S	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
	0	0	1	1	AC5	AC4	AC3	AC2	AC1	AC0

Z address(AC0-AC5)of the display data RAM is set in the display start line register and displayed at the top of the screen.

When the display duty cycle is 1/64 or others (1/32-1/64),the data of total line number of LCD screen, from the line specified by display start line instruction, is displayed.

5.Status Read

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1 I	D B0
1	0	BUSY	0	ON/OFF	RESET	0	0	0	0

• BUSY

When BUSY is 1, the Chip is executing internal operation and no instructions are accepted.

When BUSY is 0, the Chip is ready to accept any instructions.

• ON/OFF

When ON/OFF is 1, the display is on.

When ON/OFF is 0, the display is off.

• RESET

When RESET is 1, the system is being initialized.

In this condition, no instructions except status can be accepted.

When RESET is 0, initializing has finished and the system is in the usual operation condition.

6.Write Display Data

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	2 XIV	D7	D6	D5	D4	D3	D2	D1	D0

Writes data (D0-D7)into the display data RAM.

After writing instruction, Y address is increased by 1 automatically.

7.Read Display Data

 RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

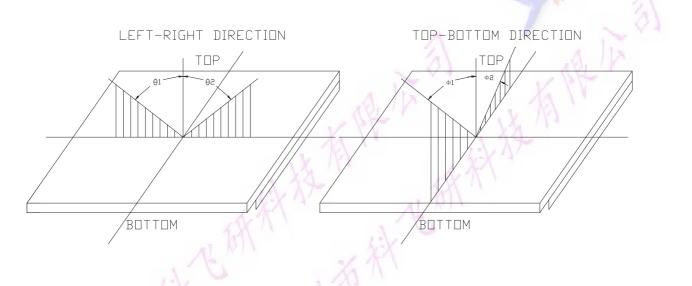
Reads data(D0-D7) from the display data RAM.

After reading instruction, Y address is increased by 1 automatically.

11.OPTICAL CHARACTERISTICS:

ITEM	SYMBOL	CONDITION	MIN.	ТҮР.	MAX.	UNIT	REF.
Contrast	CR	25°C, Vdd=5V, $\theta = 0, \emptyset = 0$		12			(2)
Rise Time	Tr	25°C, Vdd=5V, $\theta = 0, \emptyset = 0$		160	240	ms	(3)
Fall Time	Tf	25°C, Vdd=5V, $\theta = 0, \emptyset = 0$		100	150	ms	(3)
Viewing Angle	θ 1- θ 2	25℃			60	DEG	(1)
Viewing Angle	Ø1, Ø2	23 C	-40		40		

(1)Definition of viewing Angle:



(2)Definition of Contrast Ratio:

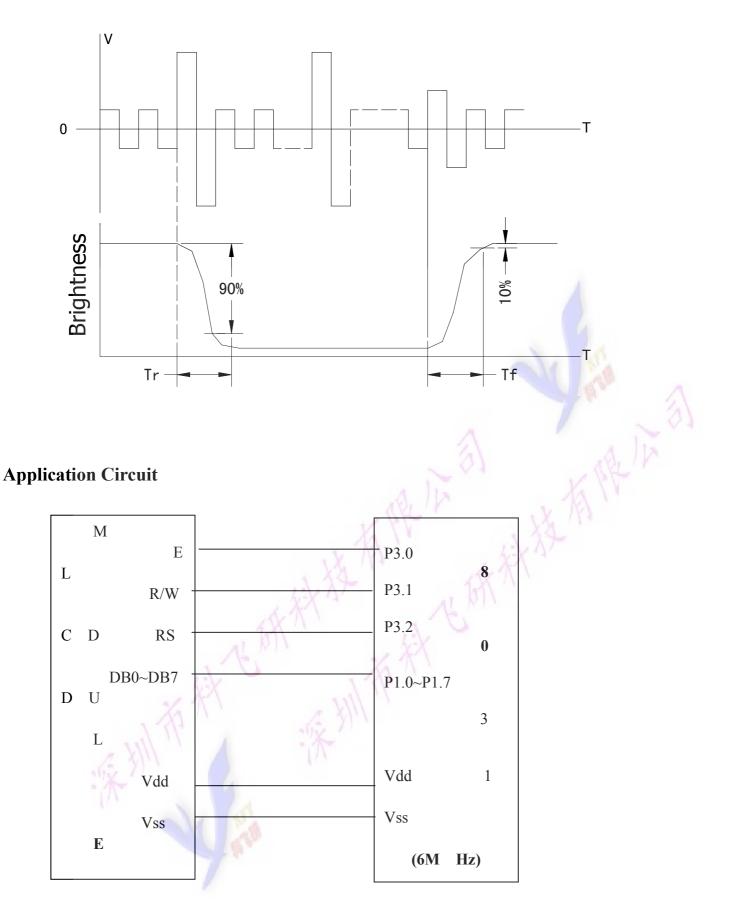
Contrast Ratio= <u>Brightness of non-selected condition</u> <u>Brightness of selected condition</u> Test condition: standard A light source

(3)Response Time:

Response time is measured as the shortest period of possible between the change in state of

an LCD segments as demonstrated below:

12. APPLICATION EXAMPLE



Application Flowchart



13. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzine.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

(1). Do not tamper in any way with the tabs on the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pie ls.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.
- (3). Only properly grounded soldering irons should be used.
- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3. Soldering

- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature: 280 °C \pm 10°C
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

